Breadboard / Solderless
ABS

Specifications:

- **Pitch**: 2.54mm
- **Terminal Strips**: 630 Tie-point
- **Distribution Strips**: 200 Tie-point
- **Rated Voltage / Current**: 300V / 3 to 5A
- **Insulation Resistance**: 500MΩ / DC500V
- **Withstanding Voltage**: 1,000V AC / 1 minute
- **Wire Range**: 29AWG to 20AWG
- **Temperature Range**: -25°C to +80°C
- **Strip Length**: 7mm to 8mm

Dimensions: Millimetres

1. Terminal Strip
2. Distribution Strips

**Part Number Table**

<table>
<thead>
<tr>
<th>Description</th>
<th>Part Number</th>
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<tbody>
<tr>
<td>Breadboard / Solderless, ABS</td>
<td>MCB830</td>
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